Power MOSFET 30 V, 58.5 A, Single N-Channel, SO-8 FL

Features

- Low R_{DS(on)} to Minimize Conduction Losses
- Low Capacitance to Minimize Driver Losses
- Optimized Gate Charge to Minimize Switching Losses
- Thermally Enhanced SO-8 Package
- These are Pb-Free Device

Applications

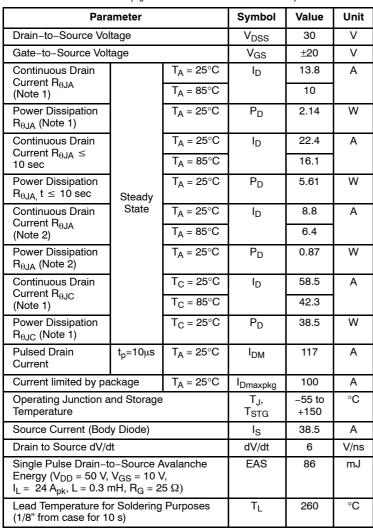
- CPU Power Delivery
- DC-DC Converters
- High Side Switching



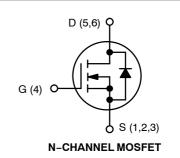
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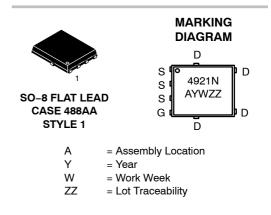
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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
30 V	6.95 mΩ @ 10 V	
50 V	10.8 mΩ @ 4.5 V	58.5 A



Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.





ORDERING INFORMATION

Device	Package	Shipping [†]
NTMFS4921NT1G	SO-8FL (Pb-Free)	1500 / Tape & Reel
NTMFS4921NT3G	SO-8FL (Pb-Free)	5000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MAXIMUM RATINGS (T_J = 25°C unless otherwise stated)

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case (Drain)	$R_{ ext{ heta}JC}$	3.25	
Junction-to-Ambient - Steady State (Note 1)	R_{\thetaJA}	58.3	°C/W
Junction-to-Ambient - Steady State (Note 2)	R_{\thetaJA}	144.1	0/00
Junction-to-Ambient – t \leq 10 sec	$R_{ hetaJA}$	22.3	

Surface-mounted on FR4 board using 1 sq-in pad, 1 oz Cu.
Surface-mounted on FR4 board using the minimum recommended pad size.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS				-	-		
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D =	250 μΑ	30			V
Drain-to-Source Breakdown Voltage (transient)	V _{(BR)DSSt}	$\label{eq:VGS} \begin{array}{l} V_{GS} = 0 \mbox{ V, } I_{D(aval)} = 13 \mbox{ A,} \\ T_{case} = 25^{\circ} C, t_{transient} = 100 \mbox{ ns} \end{array}$		34			v
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				25		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V,$	$T_J = 25^{\circ}C$			1	
		V _{DS} = 24 V	$v_{DS} = 24 \text{ V}$ T _J = 125°C			10	μΑ
Gate-to-Source Leakage Current	I _{GSS}	V_{DS} = 0 V, V_{GS} = ±20 V				±100	nA
ON CHARACTERISTICS (Note 3)							
Gate Threshold Voltage	V _{GS(TH)}	V_{GS} = V_{DS} , I_D = 250 μ A		1.45	1.8	2.5	V
Nexetian Three held Terror and an Ora (fished	м т			1		Ī	

Gale Theshold Vollage	VGS(TH)	$v_{\rm GS} = v_{\rm DS}, v_{\rm D} =$	230 μΑ	1.45	1.0	2.5	v
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J		-				mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V to 11.5 V	I _D = 30 A		5.3	6.95	
		11.5 V	l _D = 15 A		5.2		mΩ
		V _{GS} = 4.5 V	I _D = 30 A		8.6	10.8	11152
			I _D = 15 A		8.4		
Forward Transconductance	9 _{FS}	V _{DS} = 1.5 V, I _D) = 30 A		54		S

CHARGES AND CAPACITANCES

Input Capacitance	C _{ISS}		1400		
Output Capacitance	C _{OSS}	V_{GS} = 0 V, f = 1 MHz, V_{DS} = 12 V	282		pF
Reverse Transfer Capacitance	C _{RSS}		136		
Total Gate Charge	Q _{G(TOT)}		10.7	16	
Threshold Gate Charge	Q _{G(TH)}	V_{GS} = 4.5 V, V_{DS} = 15 V; I_{D} = 30 A	1.4		-0
Gate-to-Source Charge	Q _{GS}		4.1		nC
Gate-to-Drain Charge	Q _{GD}		3.8		
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 11.5 V, V_{DS} = 15 V, I _D = 30 A	25		nC

SWITCHING CHARACTERISTICS (Note 4)

Turn-On Delay Time	t _{d(ON)}		13.3	
Rise Time	t _r	V _{GS} = 4.5 V, V _{DS} = 15 V, I _D = 15 A,	38	
Turn-Off Delay Time	t _{d(OFF)}	$R_G = 3.0 \ \Omega$	16.6	ns
Fall Time	t _f		3.8	

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
SWITCHING CHARACTERISTICS (N	ote 4)						
Turn-On Delay Time	t _{d(ON)}				8.2		
Rise Time	tr	V _{GS} = 11.5 V, V _I	_{0S} = 15 V,		20		1
Turn-Off Delay Time	t _{d(OFF)}	V_{GS} = 11.5 V, V_{DS} = 15 V, I _D = 15 A, R _G = 3.0 Ω			23		ns
Fall Time	t _f				3.1		
DRAIN-SOURCE DIODE CHARACTE	ERISTICS						
Forward Diode Voltage	V _{SD}	$V_{SD} \qquad V_{GS} = 0 V, \\ I_S = 30 A \qquad T_J = 25^{\circ}C \\ T_J = 125^{\circ}C$		0.85	1.0		
				0.74		V	
Reverse Recovery Time	t _{RR}				11		
Charge Time	t _a	V _{GS} = 0 V, dI _S /dt =	= 100 A/μs,		7.5		ns
Discharge Time	t _b	$I_{\rm S} = 30 {\rm A}$			3.5		
Reverse Recovery Charge	Q _{RR}				2.0		nC
PACKAGE PARASITIC VALUES							
Source Inductance	L _S	T _A = 25°C			1.3		nH
Drain Inductance	L _D				0.005		
Gate Inductance	L _G				1.84		
				<u> </u>	1		

0.5

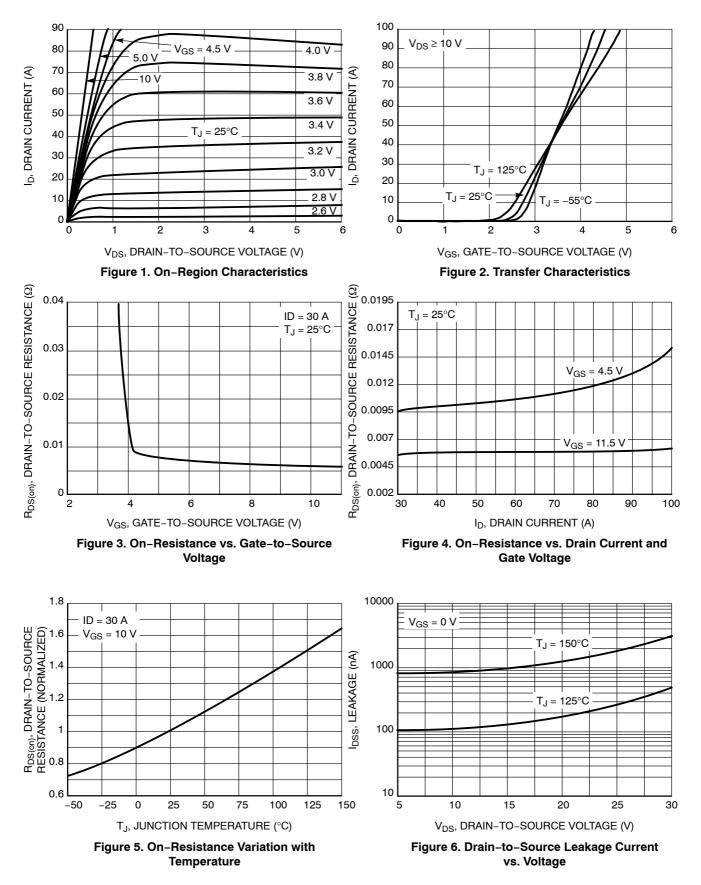
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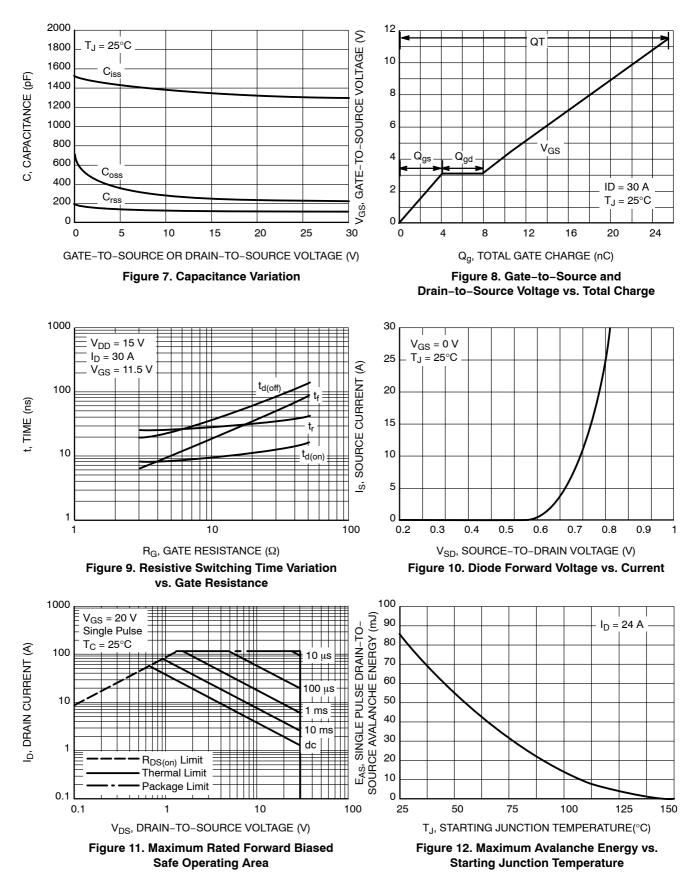
2.0

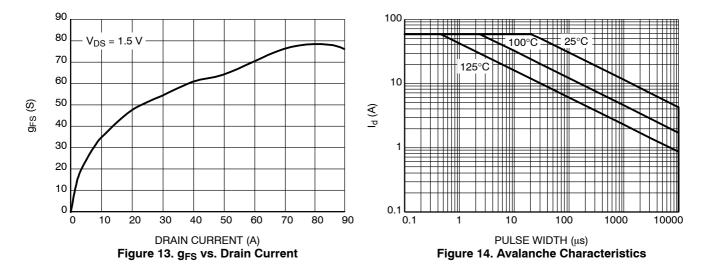
Ω

Gate Resistance

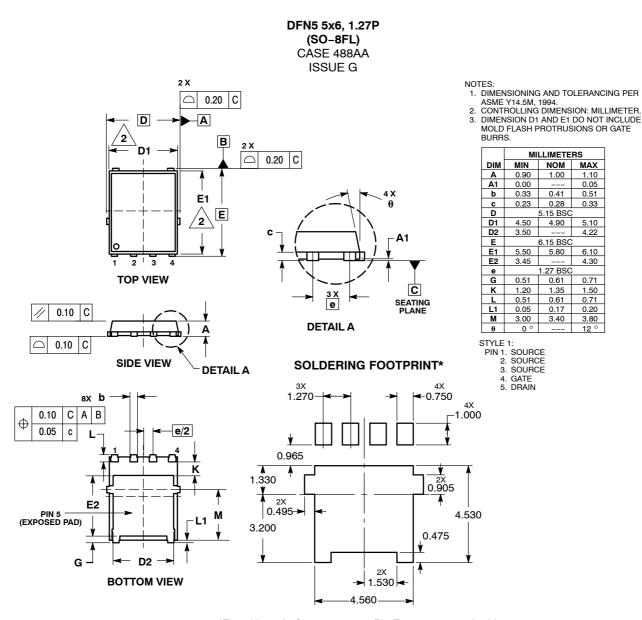
 R_G







PACKAGE DIMENSIONS



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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